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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
	A salinos
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	LINbus, SIO, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	25
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f212e2nfp-w4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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1.1.2 Specifications

Tables 1.1 and 1.2 outlines the Specifications for R8C/2E Group and Tables 1.3 and 1.4 outlines the Specifications for R8C/2F Group.

Table 1.1 Specifications for R8C/2E Group (1)

Item	Function	Specification
CPU	Central	R8C/Tiny series core
	processing unit	Number of fundamental instructions: 89
		Minimum instruction execution time:
		50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
		• Multiplier: 16 bits × 16 bits → 32 bits
		• Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits
		Operation mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM	Refer to Table 1.5 Product List for R8C/2E Group.
Power Supply	Voltage	Power-on reset
Voltage	detection circuit	Voltage detection 2
Detection		Totage detection _
I/O Ports	Programmable	Input-only: 3 pins
,, 0 , 0, 10	I/O ports	CMOS I/O ports: 25, selectable pull-up resistor
	" o porto	• High current drive ports: 8
Clock	Clock generation	2 circuits: XIN clock oscillation circuit (with on-chip feedback resistor),
Olook	circuits	On-chip oscillator (high-speed, low-speed)
	Onouns	(high-speed on-chip oscillator has a frequency adjustment
		function)
		Oscillation stop detection: XIN clock oscillation stop detection
		function
		• Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16
		• Low power consumption modes:
		Standard operating mode (high-speed clock, high-speed on-chip
Interrupte		oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		• External: 4 sources, Internal: 13 sources, Software: 4 sources
Watchdog Tim	or	 Priority levels: 7 levels 15 bits x 1 (with prescaler), reset start selectable
Timer	Timer RA	8 bits × 1 (with 8-bit prescaler)
Tillel	Tilllel KA	Timer mode (period timer), pulse output mode (output level inverted
		every period), event counter mode, pulse width measurement mode,
		pulse period measurement mode
	Timer RB	8 bits × 1 (with 8-bit prescaler)
	Tilliel IXD	Timer mode (period timer), programmable waveform generation
		mode (PWM output), programmable one-shot generation mode,
		programmable wait one-shot generation mode
	Timer RC	16 bits × 1 (with 4 capture/compare registers)
	Timer ive	Timer mode (input capture function, output compare function), PWM
		mode (output 3 pins), PWM2 mode (PWM output pin)
	Timer RE	8 bits × 1
		Output compare mode
Serial	UART0	Clock synchronous serial I/O/UART x 1
Interface		
LIN Module	l	Hardware LIN: 1 (timer RA, UART0)
A/D Converter	•	10-bit resolution × 12 channels, includes sample and hold function
D/A Converter		8-bit resolution × 2 circuits
Comparator		2 circuits
		1

Table 1.2 Specifications for R8C/2E Group (2)

Item	Specification
Flash Memory	 Programming and erasure voltage: VCC = 2.7 to 5.5 V
	Programming and erasure endurance: 100 times
	Program security: ROM code protect, ID code check
	Debug functions: On-chip debug, on-board flash rewrite function
Operating Frequency/Supply	f(XIN) = 20 MHz (VCC = 3.0 to 5.5 V),
Voltage	f(XIN) = 10 MHz (VCC = 2.7 to 5.5 V)
Current consumption	Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 6 mA (VCC = 3.0 V, f(XIN) = 10 MHz)
	Typ. 23 μ A (VCC = 3.0 V, wait mode (peripheral clock off)) Typ. 0.7 μ A (VCC = 3.0 V, stop mode)
Operating Ambient Temperature	-20 to 85°C (N version)
Operating Ambient Temperature	-40 to 85°C (D version) ⁽¹⁾
Package	32-pin LQFP
	Package code: PLQP0032GB-A (previous code: 32P6U-A)

1. Specify the D version if D version functions are to be used.

Table 1.6 Product List for R8C/2F Group

Current of Dec. 2007

Part No.	ROM Ca	apacity	RAM	Package Type	Remarks
Fait No.	Program ROM	Data flash	Capacity	rackage Type	Remarks
R5F212F2NFP	8 Kbytes	1 Kbyte x 2	512 bytes	PLQP0032GB-A	N version
R5F212F4NFP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLQP0032GB-A	
R5F212F2DFP	8 Kbytes	1 Kbyte x 2	512 bytes	PLQP0032GB-A	D version
R5F212F4DFP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLQP0032GB-A	
R5F212F2NXXXFP	8 Kbytes	1 Kbyte x 2	512 bytes	PLQP0032GB-A	N version
R5F212F4NXXXFP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLQP0032GB-A	Factory programming
					product ⁽¹⁾
R5F212F2DXXXFP	8 Kbytes	1 Kbyte x 2	512 bytes	PLQP0032GB-A	D version
R5F212F4DXXXFP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLQP0032GB-A	Factory programming
					product ⁽¹⁾

NOTE:

1. The user ROM is programmed before shipment.

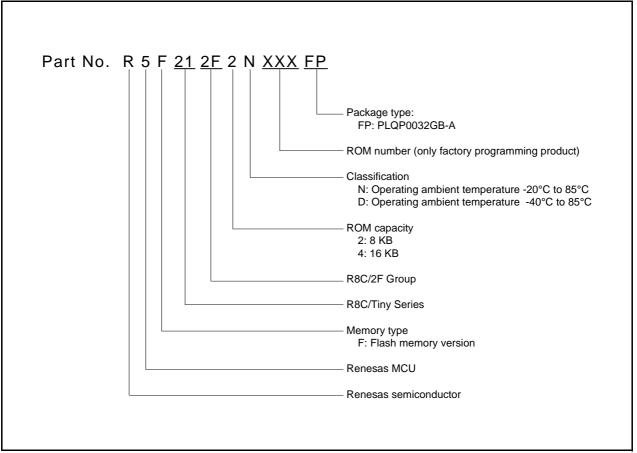


Figure 1.2 Part Number, Memory Size, and Package of R8C/2F Group

1.4 Pin Assignment

Figure 1.4 shows Pin Assignments (Top View). Table 1.7 outlines the Pin Name Information by Pin Number.

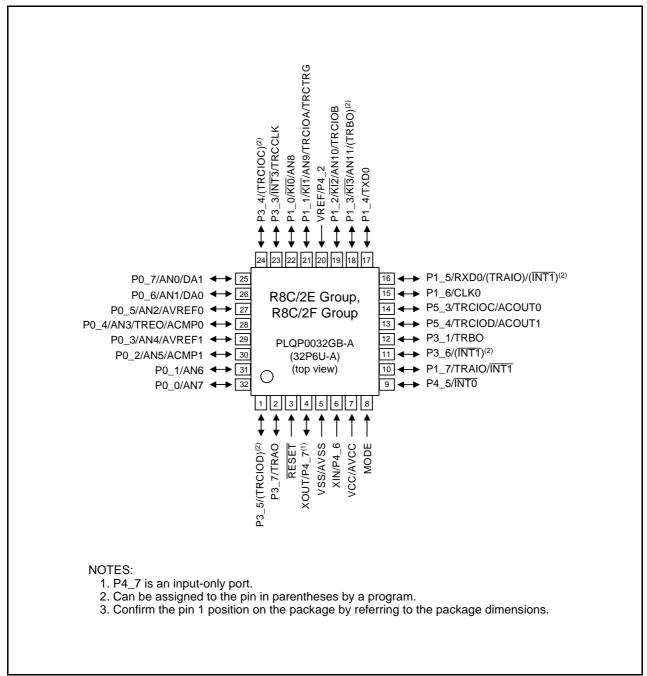


Figure 1.4 Pin Assignments (Top View)

2. **Central Processing Unit (CPU)**

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

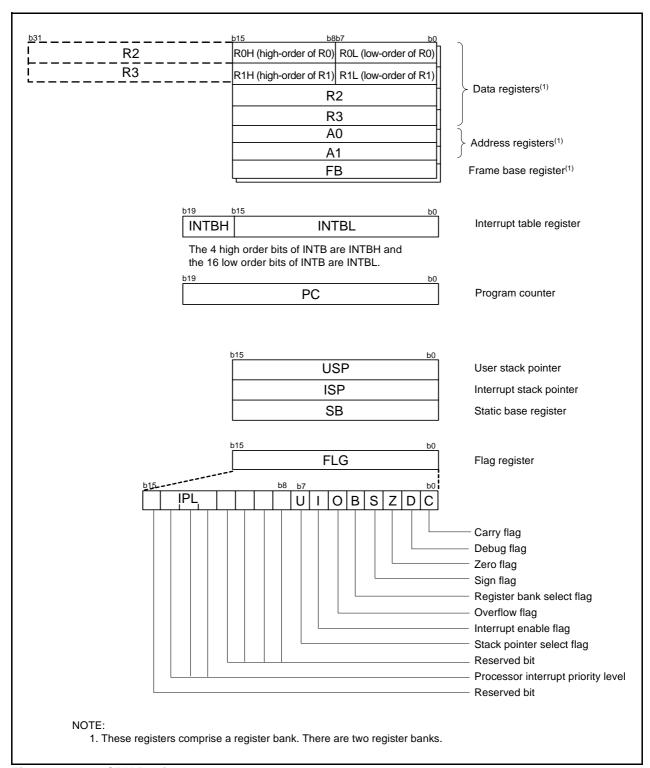


Figure 2.1 **CPU Registers**

2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 to be used as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP, and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 **Zero Flag (Z)**

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 **Sign Flag (S)**

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.



2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupt are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.



3.2 R8C/2F Group

Figure 3.2 is a Memory Map of R8C/2F Group. The R8C/2F group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM area is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

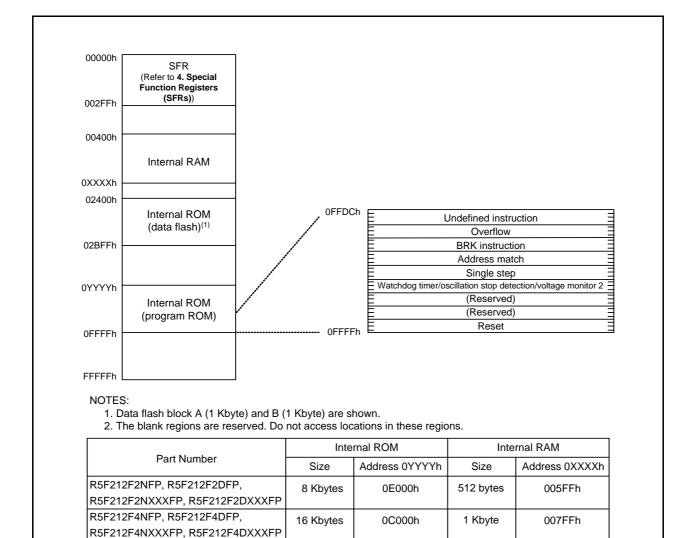


Figure 3.2 Memory Map of R8C/2F Group

SFR Information (3)⁽¹⁾ Table 4.3

Address	Register	Symbol	After reset
0080h	r togistor	Cymbol	71101 10001
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0090H			
009111 0092h			
0092h 0093h			
0093h 0094h			
0095h 0096h			
0096h 0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UARTO Bit Rate Register	U0BRG	XXh
00A1h 00A2h	UARTO Bit Rate Register UARTO Transmit Buffer Register		XXh XXh
00A1h 00A2h 00A3h	UART0 Bit Rate Register UART0 Transmit Buffer Register	U0BRG U0TB	XXh XXh XXh
00A1h 00A2h 00A3h 00A4h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0	U0BRG U0TB U0C0	XXh XXh XXh 00001000b
00A1h 00A2h 00A3h 00A4h 00A5h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 0000010b
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0	U0BRG U0TB U0C0	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 0000010b
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00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh 00AEh 00AFh 00B0h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AEh 00AEh 00AEh 00AEh 00AEh 00AEh 00AEh 00B0h 00B1h 00B2h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
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00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B1h 00B2h 00B3h 00B4h 00B5h 00B5h 00B7h 00B8h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B0h 00B1h 00B2h 00B3h 00B5h 00B6h 00B5h 00B6h 00B7h 00B8h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B1h 00B2h 00B3h 00B5h 00B6h 00B7h 00B8h 00B8h 00B9h	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00BAh 00BAh 00BB	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B9h 00BAh 00BCh	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00BAh 00BAh 00BAh	UART0 Bit Rate Register UART0 Transmit Buffer Register UART0 Transmit/Receive Control Register 0 UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (4)⁽¹⁾ Table 4.4

Address	Register	Symbol	After reset
00C0h	A/D Register	AD	XXh
00C1h			XXh
00C2h			
00C3h			
00C4h			
00C5h			
00C6h			
00C7h			
00C8h			
00C9h			
00CAh			
00CAII			
00CCh			
00CDh			
00CEh			
00CFh			
00D0h			
00D1h			
00D2h			
00D3h			
00D4h	A/D Control Register 2	ADCON2	00h
00D5h			
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h	D/A Register 0	DA0	00h
00D9h			
00DAh	D/A Register 1	DA1	00h
00DBh		-: ;;	
00DCh	D/A Control Register	DACON	00h
00DDh	Diff Control (Cogleto)	Briceri	0011
00DEh			
00DFh			
00E0h	Port P0 Register	P0	00h
00E0H			
	Port P1 Register	P1	00h
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h			
00E5h	Port P3 Register	P3	00h
00E6h			
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	00h
00E9h	Port P5 Register	P5	00h
00EAh	Port P4 Direction Register	PD4	00h
00EBh	Port P5 Direction Register	PD5	00h
00ECh			
00EDh			
00EEh			
00EFh			
00F0h			
00F1h			
00F2h			
00F3h			
00F3f1			
00F5h	L Din Colort Progietor 2	PINSR2	00h
00F6h	Pin Select Register 2		
00F7h	Pin Select Register 3	PINSR3	00h
00F8h	Port Mode Register	PMR	00h
00F9h	External Input Enable Register	INTEN	00h
00FAh	INT Input Filter Select Register	INTF	00h
	Key Input Enable Register	KIEN	00h
00FBh			
00FBh 00FCh	Pull-Up Control Register 0	PUR0	00h
00FBh 00FCh 00FDh	Pull-Up Control Register 0 Pull-Up Control Register 1	PUR0 PUR1	
00FBh 00FCh	Pull-Up Control Register 0	PUR0	00h

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (5)⁽¹⁾ Table 4.5

Address	Dogistor	Symbol	After reset
0100h	Register Timer RA Control Register	Symbol TRACR	After reset
		_	
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h			
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
0103h	Timer RB I/O Control Register	TRBIOC	00h
	Time RD I/O Control Register		
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0112H			+
0114h			+
			_
0115h			
0116h			
0117h			
0118h	Timer RE Counter Data Register	TRESEC	00h
0119h	Timer RE Compare Data Register	TREMIN	00h
011Ah	·		
011Bh			1
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Clock Source Select Register	TRECSR	00001000b
	Tiller RE Clock Source Select Register	TRECOR	000010000
011Fh	T POW I P I I		0.400.400.01
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h	Timor No Counter	1110	00h
0127H	Timer RC General Register A	TRCGRA	FFh
0129h	Tilliei No Gerielai Negistei A	TROGRA	
		TD0000	FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh			FFh
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh	<u>-</u>		FFh
0130h	Timer RC Control Register 2	TRCCR2	00011111b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0131h	Timer RC Output Master Enable Register	TRCOER	01111111b
0132h	Timor No Odiput Master Eriable Negister	INCOLIN	011111110
			ļ
0134h			4
0135h			
0136h			
0137h			
0138h			
0139h			1
013Ah			†
013Bh			†
013Ch			+
			
013Dh			
013Eh			
013Fh			
X: Undefined			

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

Table 5.7 Flash Memory (Data flash Block A, Block B) Electrical Characteristics(4)

Symbol	Parameter	Conditions		Unit		
Symbol	Parameter	Conditions	Min.	Min. Typ. Max.		Unit
_	Program/erase endurance ⁽²⁾		10,000(3)	-	-	times
_	Byte program time (program/erase endurance ≤ 1,000 times)		_	50	400	μS
_	Byte program time (program/erase endurance > 1,000 times)		_	65	_	μS
_	Block erase time (program/erase endurance ≤ 1,000 times)		_	0.2	9	S
_	Block erase time (program/erase endurance > 1,000 times)		_	0.3	-	S
td(SR-SUS)	Time delay from suspend request until suspend		=	-	97+CPU clock × 6 cycles	μS
_	Interval from erase start/restart until following suspend request		650	-	_	μS
_	Interval from program start/restart until following suspend request		0	-	-	ns
_	Time from suspend until program/erase restart		_	-	3+CPU clock × 4 cycles	μS
-	Program, erase voltage		2.7	_	5.5	V
_	Read voltage		2.7	_	5.5	V
=	Program, erase temperature		-20 ⁽⁸⁾	-	85	°C
_	Data hold time ⁽⁹⁾	Ambient temperature = 55 °C	20	_	-	year

- 1. Vcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. Standard of block A and block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times is the same as that in program ROM.
- 5. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 6. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 8. –40°C for D version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

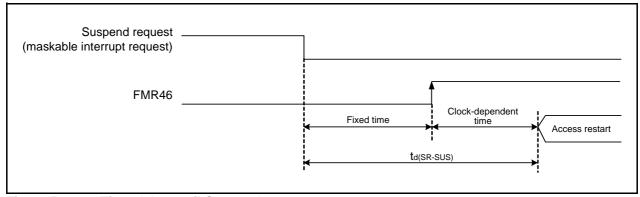


Figure 5.2 Time delay until Suspend

Table 5.8 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Syllibol	raidilletei	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ⁽⁴⁾		2.7	2.85	3.00	V
_	Voltage monitor 1 interrupt request generation time ⁽²⁾		_	40	_	μS
=	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	=	0.6	=	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		=	=	100	μ\$
Vccmin	MCU operating voltage minimum value		2.7	_	=	V

- 1. The measurement condition is Vcc = 2.7 V to 5.5 V and $T_{opr} = -20 \text{ to } 85^{\circ}C$ (N version) / $-40 \text{ to } 85^{\circ}C$ (D version).
- 2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

Table 5.9 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level		3.3	3.6	3.9	V
-	Voltage monitor 2 interrupt request generation time ⁽²⁾		_	40	-	μS
-	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		I	=	100	μ\$

- 1. The measurement condition is Vcc = 2.7 V to 5.5 V and $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version).
- $2. \quad \text{Time until the voltage monitor 2 interrupt request is generated after the voltage passes V_{det2}.}$
- 3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.



Table 5.11 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard		Unit
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	Vcc = 4.75 V to 5.25 V 0° C \leq Topr \leq 60°C(2)	39.2	40	40.8	MHz
		Vcc = 3.0 V to 5.5 V $-20^{\circ}\text{C} \le \text{Topr} \le 85^{\circ}\text{C}^{(2)}$	38.8	40	41.2	MHz
		Vcc = 3.0 V to 5.5 V $-40^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.4	40	41.6	MHz
		Vcc = 2.7 V to 5.5 V -20°C \le Topr \le 85°C ⁽²⁾	38	40	42	MHz
		Vcc = 2.7 V to 5.5 V -40°C \le Topr \le 85°C(2)	37.6	40	42.4	MHz
		$Vcc = 5.0 \text{ V } \pm 10\%$ $-20^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.8	40	40.8	MHz
		$Vcc = 5.0 \text{ V } \pm 10\%$ $-40^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.4	40	40.8	MHz
	High-speed on-chip oscillator frequency when	Vcc = 5.0 V, Topr = 25°C	_	36.864	_	MHz
	correction value in FRA7 register is written to FRA1 register	Vcc = 2.7 V to 5.5 V -20°C ≤ Topr ≤ 85°C	-3%	-	3%	%
_	Value in FRA1 register after reset		08h	-	F7h	_
_	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	-	+0.3	-	MHz
=	Oscillation stability time		-	10	100	μS
=	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	=	400	_	μΑ

- 1. Vcc = 2.7 to 5.5 V, $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. These standard values show when the FRA1 register value after reset is assumed.

Table 5.12 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falametei	Condition	Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
=	Oscillation stability time		=	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	=	15	=	μΑ

NOTE:

1. Vcc = 2.7 to 5.5 V, $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.

Table 5.13 Power Supply Circuit Timing Characteristics

Svmbol	Parameter	Condition	,	Standard	d l	Unit
Syllibol	Falametei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μS
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr = 25°C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



Table 5.15 Electrical Characteristics (2) [Vcc = 5 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

	D	O control o		Standard			11.2
Symbol	Parameter		Condition	Min. Typ. Max.			Unit
CC	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode,	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	10	17	mA
	output pins are open, other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	9	15	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	6	_	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	5	-	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	4	_	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2.5	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	10	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	4	-	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	5.5	10	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2.5	_	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	_	130	300	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = 0 VCA20 = 1	-	25	75	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = 0 VCA20 = 1	-	23	60	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = 0	-	0.8	3.0	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off	-	1.2	_	μА

Timing Requirements

(Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Symbol Parameter -		Standard		
Symbol			Max.	Unit	
tc(XIN)	XIN input cycle time	50	-	ns	
twh(xin)	XIN input "H" width	25	-	ns	
twl(XIN)	XIN input "L" width	25	-	ns	

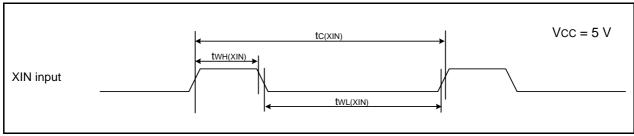


Figure 5.4 XIN Input Timing Diagram when Vcc = 5 V

Table 5.17 TRAIO Input

Symbol	Parameter		Standard	
Symbol			Max.	Unit
tc(TRAIO)	TRAIO input cycle time	100	=	ns
tWH(TRAIO)	TRAIO input "H" width	40	=	ns
tWL(TRAIO)	TRAIO input "L" width	40	-	ns

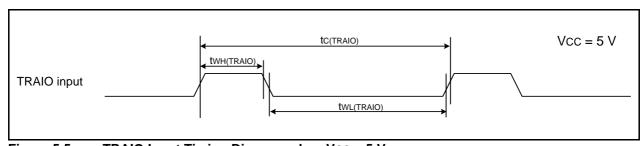


Figure 5.5 TRAIO Input Timing Diagram when Vcc = 5 V

Table 5.18 Serial Interfa	Table	5.18	Serial	Interfac
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Symbol	Parameter		Standard		
Symbol	Farameter	Min.	Max.	Unit	
tc(CK)	CLK0 input cycle time	200	-	ns	
tW(CKH)	CLK0 input "H" width	100	-	ns	
tW(CKL)	CLK0 input "L" width	100	-	ns	
td(C-Q)	TXD0 output delay time	-	50	ns	
th(C-Q)	TXD0 hold time	0	-	ns	
tsu(D-C)	RXD0 input setup time	50	=	ns	
th(C-D)	RXD0 input hold time	90	-	ns	

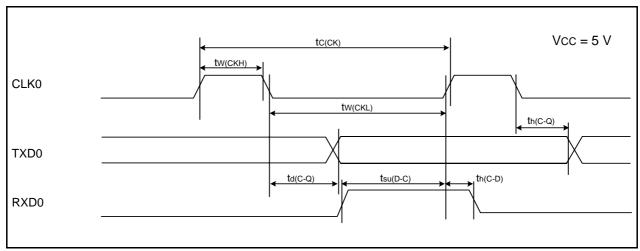


Figure 5.6 Serial Interface Timing Diagram when Vcc = 5 V

Table 5.19 External Interrupt INTi (i = 0, 1, 3) Input

Symbol	Symbol Parameter -		Standard	
Symbol			Max.	Unit
tW(INH)	ĪNTi input "H" width	250 ⁽¹⁾	-	ns
tW(INL)	INTi input "L" width	250(2)	-	ns

- 1. When selecting the digital filter by the INTi input filter select bit, use an INTi input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

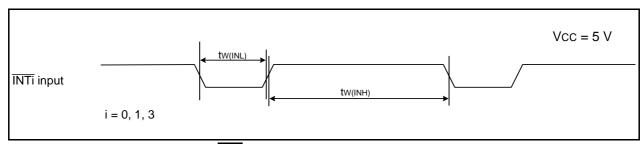


Figure 5.7 External Interrupt INTi Input Timing Diagram when Vcc = 5 V

Table 5.20 Electrical Characteristics (3) [Vcc = 3 V]

Cumbal	Dor	amatar	Cons	dition	Standard			Unit
Symbol	Para	ameter	Condition		Min.	Тур.	Max.	Unit
Voн	Output "H" voltage	Except P1_0 to P1_7, XOUT	Iон = −1 mA		Vcc - 0.5	_	Vcc	V
		P1_0 to P1_7	Drive capacity HIGH	Iон = −2 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	Iон = −1 mA	Vcc - 0.5	_	Vcc	V
		XOUT	Drive capacity HIGH	Iон = −0.1 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	IOH = -50 μA	Vcc - 0.5	_	Vcc	V
Vol	Output "L" voltage	Except P1_0 to P1_7, XOUT	IoL = 1 mA		_	_	0.5	V
		P1_0 to P1_7	Drive capacity HIGH	IoL = 2 mA	_	_	0.5	V
			Drive capacity LOW	IOL = 1 mA	=	_	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	-	=	0.5	V
			Drive capacity LOW	IOL = 50 μA	=	_	0.5	V
VT+-VT-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, CLK0			0.1	0.3	_	V
		RESET			0.1	0.4	_	V
Iн	Input "H" current	1	VI = 3 V, Vcc = 3 V		-	-	4.0	μА
lı∟	Input "L" current	_	VI = 0 V, $Vcc = 3$	3 V	=	-	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V, VCC = 3	3 V	66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	-	MΩ
VRAM	RAM hold voltage		During stop mod	e	1.8	-	-	V

^{1.} Vcc = 2.7 to 3.3 V at $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), f(XIN) = 10 MHz, unless otherwise specified.

Table 5.24 Senai interface	Table	5.24	Serial	Interface
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Symbol	Doromotor		Standard		
Symbol	Parameter	Min.	Max.	Unit	
tc(CK)	CLK0 input cycle time	300	-	ns	
tW(CKH)	CLK0 input "H" width	150	=	ns	
tW(CKL)	CLK0 Input "L" width	150	=	ns	
td(C-Q)	TXD0 output delay time	=	80	ns	
th(C-Q)	TXD0 hold time	0	=	ns	
tsu(D-C)	RXD0 input setup time	70	=	ns	
th(C-D)	RXD0 input hold time	90	_	ns	

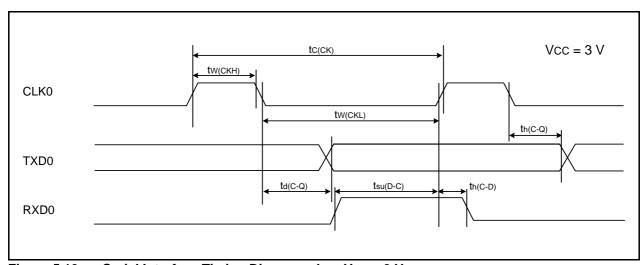


Figure 5.10 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.25 External Interrupt INTi (i = 0, 1, 3) Input

Symbol	Parameter		Standard		
Symbol	Falanielei	Min.	Max.	Unit	
tW(INH)	INTi input "H" width	380 ⁽¹⁾	-	ns	
tw(INL)	INTi input "L" width	380(2)	-	ns	

- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

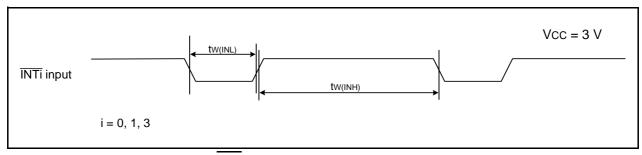


Figure 5.11 External Interrupt INTi Input Timing Diagram when Vcc = 3 V